

MIC94310

200 mA LDO with Ripple BlockerTM Technology

Features

- 1.8V to 3.6V Input Voltage Range
- Active Noise Rejection Over a Wide Frequency Band: >50 dB from 10 Hz to 10 MHz at 200 mA Load
- Rated to 200 mA Output Current
- · Fixed Output Voltages
- · Current-Limit and Thermal-Limit Protected
- 1.2 mm x 1.6 mm 4-Pin TDFN
- 5-Pin SOT-23
- Ultra-Small 0.88 mm x 0.88 mm WLCSP
- Logic-Controlled Enable Pin
- -40°C to +125°C Junction Temperature Range

Applications

- Smartphones/Smart Books
- Tablet PC/Notebooks and Webcams
- · Digital Still and Video Cameras
- Global Positioning Systems
- Mobile Computing
- Automotive and Industrial Applications

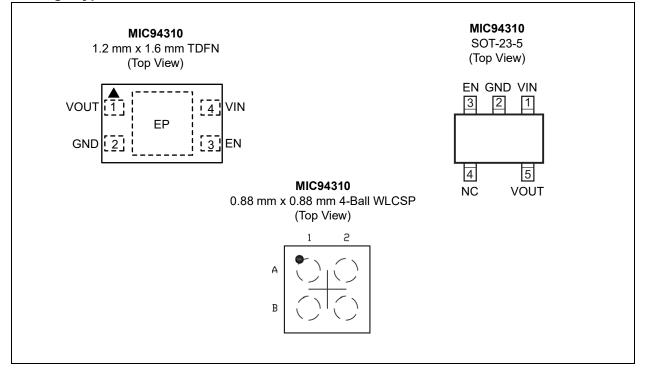
Package Types

General Description

The MIC94310 Ripple Blocker[™] is a monolithic integrated circuit that provides low-frequency ripple attenuation (switching noise rejection) to a regulated output voltage. This is important for applications where a DC/DC switching converter is required to lower or raise a battery voltage, but where switching noise cannot be tolerated by sensitive downstream circuits such as in RF applications. The MIC94310 maintains high power supply ripple rejection (PSRR) with input voltages operating near the output voltage level to improve overall system efficiency. A low-voltage logic enable pin facilitates ON/OFF control at typical GPIO voltage levels.

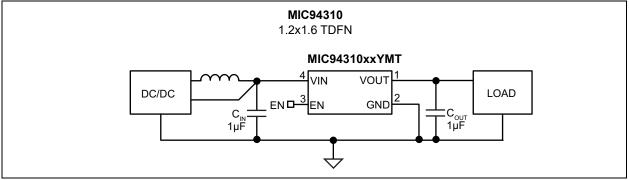
The MIC94310 operates from an input voltage of 1.8V to 3.6V.

Packaged in a 4-pin 1.2 mm × 1.6 mm TDFN, a 5-pin SOT-23, or a 0.88 mm × 0.88 mm 4-Ball WLCSP, the MIC94310 has a junction operating temperature range of -40°C to +125°C.

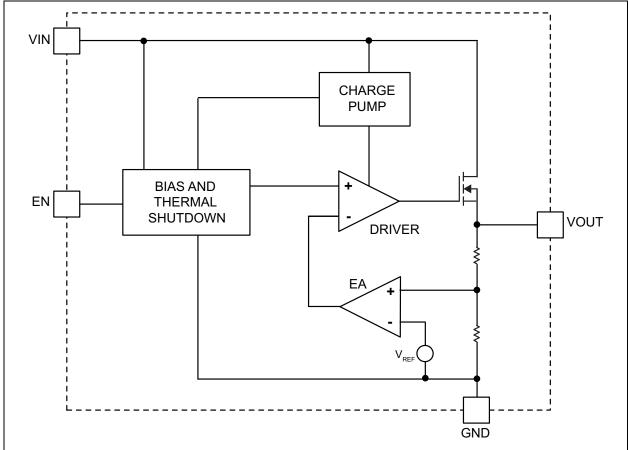


© 2018-2020 Microchip Technology Inc.

Typical Application Circuit



Functional Block Diagram



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Input Voltage, V _{IN}	
Output Voltage, V _{OUT}	
Enable Voltage, V _{EN}	
ESD Rating (Note 1)	

Operating Ratings ++

Supply Voltage, V _{IN} +1.8	√ to +3.6V
Enable Voltage, V _{EN}	.0V to V _{IN}

† Notice:Exceeding the "Absolute Maximum Ratings †" may damage the device.

†† Notice: The device is not guaranteed to function outside its operating ratings.

Note 1: Devices are ESD-sensitive. Handling precautions are recommended. Human body model, 1.5 kΩ in series with 100 pF.

ELECTRICAL CHARACTERISTICS (Note 1)

Electrical Characteristics: Unless otherwise indicated, $V_{IN} = V_{EN} = V_{OUT} + 500 \text{ mV}$ ($V_{IN} = V_{EN} = 3.6\text{V}$ for $V_{OUT} \ge 3.1\text{V}$); $I_{OUT} = 1 \text{ mA}$; $C_{OUT} = 1 \mu\text{F}$ (YMT), $C_{OUT} = 10 \mu\text{F}$ (YM5); $T_A = 25^{\circ}\text{C}$, **bold** values indicate $-40^{\circ}\text{C} \le T_J \le +125^{\circ}\text{C}$.

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions		
Input Voltage	V _{IN}	1.8	_	3.6	V	—		
Output Voltage Accuracy	V _{OUT}	-3	±1	+3	%	Variation from nominal V _{OUT}		
Drangut Voltage	V _{DO}	_	20	50	mV	V _{IN} to V _{OUT} dropout at 100 mA output current		
Dropout Voltage			40	100	mV	V _{IN} to V _{OUT} dropout at 200 mA output current		
Load Regulation	ΔV _{OUT}		4		mV	I _{OUT} = 1 mA to 100 mA		
Line Regulation	$\Delta V_{OUT} / \Delta V_{IN}$		0.01	0.5	%	$V_{IN} = V_{OUT} + 500 \text{ mV} \text{ to } 3.6 \text{V}$		
Ground Current	I _{GND}		170	250	μA	No load to full load		
Shutdown Current	I _{SHDN}		0.2	5	μA	V _{EN} = 0V		
	PSRR		85		dB	f = 100 Hz, I _{OUT} = 100 mA		
		_	68	_	dB	f = 100 kHz, I _{OUT} = 100 mA		
V _{IN} Ripple Rejection			57		dB	f = 1 MHz, I _{OUT} = 100 mA		
			50		dB	f = 10 MHz, I _{OUT} = 100 mA		
Current Limit	I _{LIM}	250	400	700	mA	V _{OUT} = 0V		
Total Output Noise	e _{no}		83		μV_{RMS}	f = 10 Hz to 100 kHz		
Turn-on Time	t _{ON}		70		μs	—		
Enable								
Input Logic Low Level	V _{EN_LOW}		_	0.4	V	_		
Input Logic High Level	V _{EN_HIGH}	1.0	_		V	_		
Enable Input Current	I _{EN}	_	0.01	1	μA	_		

Note 1: Specification for packaged product only.

^{© 2018-2020} Microchip Technology Inc.

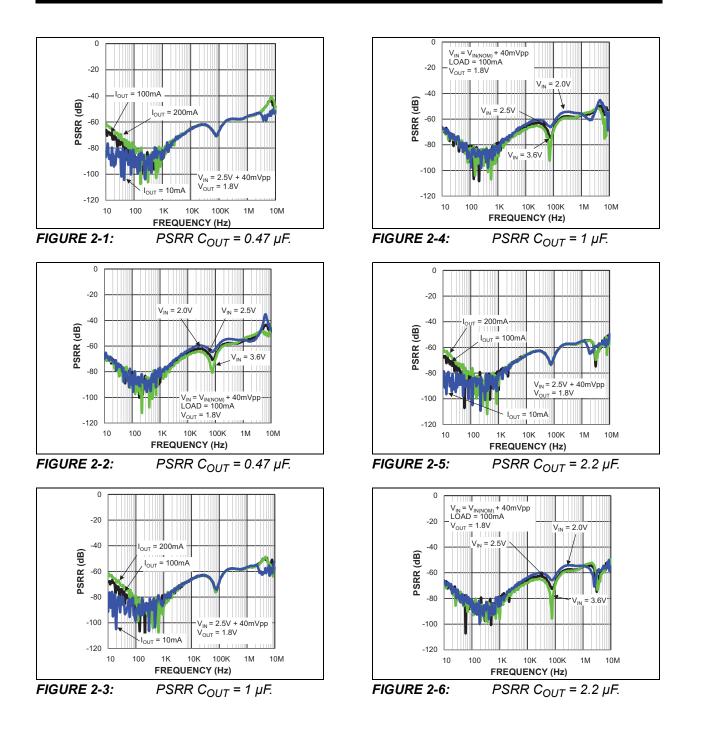
TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions	
Temperature Ranges							
Junction Operating Temperature	TJ	-40	_	+125	°C	—	
Lead Temperature	—	—	—	+260	°C	Soldering, 10 sec.	
Storage Temperature Range	Τ _S	-65	—	+150	°C	—	
Package Thermal Resistances							
Thermal Resistance, TDFN	θ_{JA}	—	173	—	°C/W	—	
Thermal Resistance, SOT-23-5Ld	θ_{JA}	—	120	—	°C/W	—	
Thermal Resistance WLCSP	θ_{JA}		250	—	°C/W	—	

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T_A, T_J, θ_{JA}). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +125°C rating. Sustained junction temperatures above +125°C can impact the device reliability.

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



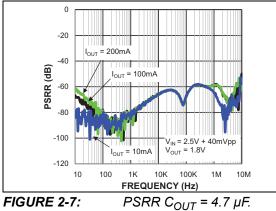
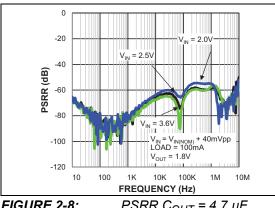
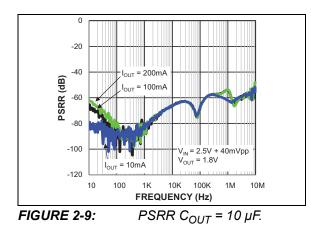


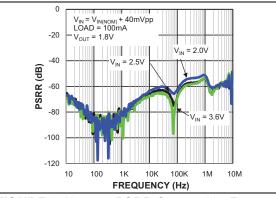
FIGURE 2-7:





PSRR C_{OUT} = 4.7 μ F.







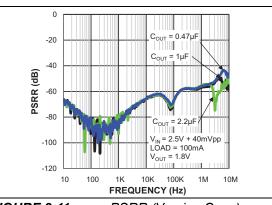


FIGURE 2-11:

PSRR (Varying C_{OUT}).

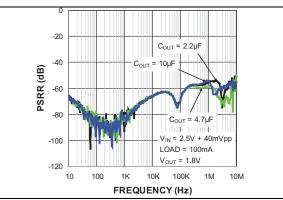


FIGURE 2-12: PSRR (Varying C_{OUT}).

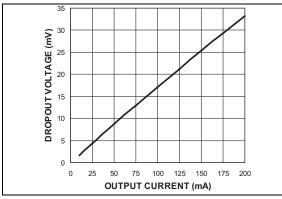


FIGURE 2-13: Drop Voltage vs. Output Current.

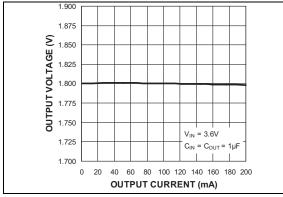


FIGURE 2-14: Current.

Output Voltage vs. Output

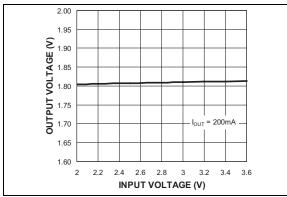


FIGURE 2-15: Output Voltage vs. Input Voltage.

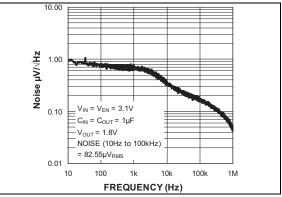


FIGURE 2-16: Output Noise Spectral Density.

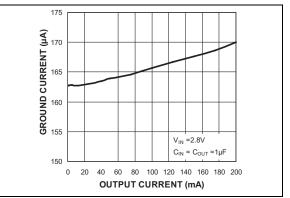


FIGURE 2-17: Ground Current vs. Output Current.

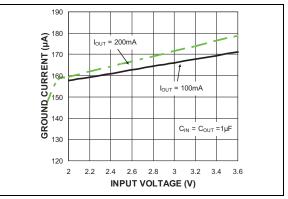


FIGURE 2-18: Ground Current vs. Input Voltage.

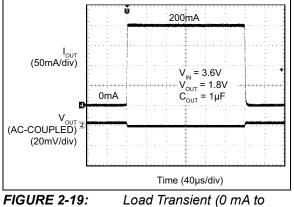


FIGURE 2-19: Load Transient (0 mA 200 mA).

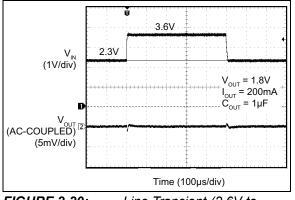


FIGURE 2-20: Line Transient (2.6V to 3.6V).

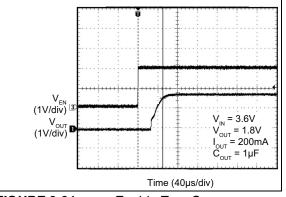
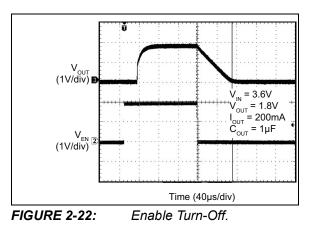


FIGURE 2-21: Enable Turn-On.



3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TADLE J-T.			-					
MIC94310 TDFN	MIC94310 SOT-23	MIC94310 WLCSP	Symbol	Description				
1	5	A2	V _{OUT}	Power Switch Output				
2	2	B2	GND	Ground				
3	3	B1	EN	Enable Input A logic HIGH signal on this pin enables the part. Logic LOW disables the part. Do not leave floating.				
4	1	A1	V _{IN}	Power switch input and chip supply				
—	4	—	NC	No Connect, not internally connected				
EP	_		EPAD	Exposed Heatsink Pad Connect to ground for best thermal performance.				

TABLE 3-1: PIN FUNCTION TABLE

^{© 2018-2020} Microchip Technology Inc.

4.0 APPLICATION INFORMATION

The MIC94310 is a very-high PSRR, fixed-output, 200 mA LDO utilizing Ripple Blocker technology. The MIC94310 is fully protected from damage due to fault conditions, offering linear current limiting and thermal shutdown.

4.1 Input Capacitor

The MIC94310 is a high-performance, high-bandwidth device. An input capacitor of 0.47 μ F is required from the input to ground to provide stability. Low-ESR ceramic capacitors provide optimal performance at a minimum of space. Additional high-frequency capacitors, such as small-valued NPO dielectric-type capacitors, help filter out high-frequency noise and are good practice in any RF-based circuit. X5R or X7R dielectrics are recommended for the input capacitor. Y5V dielectrics lose most of their capacitance over temperature and are therefore, not recommended.

4.2 Output Capacitance

In order to maintain stability, the MIC94310 requires an output capacitor of 0.47 µF or greater for the Thin DFN package and 10 µF or greater for the SOT-23 package. For optimal ripple rejection performance, a 1 µF capacitor is recommended for the Thin DFN package. A 10 µF capacitor is recommended for the SOT-23 package. The design is optimized for use with low-ESR ceramic chip capacitors. High-ESR capacitors are not recommended because they may cause high-frequency oscillation. The output capacitor can be increased, but performance has been optimized for a 1 µF ceramic output capacitor and does not improve significantly with larger capacitance.

X7R/X5R dielectric type ceramic capacitors are recommended because of their temperature performance. X7R type capacitors change capacitance by 15% over their operating temperature range and are the most stable type of ceramic capacitors. Z5U and Y5V dielectric capacitors change their value by as much as 50% and 60%, respectively, over their operating temperature ranges. To use a ceramic chip capacitor with the Y5V dielectric, the value must be much higher than an X7R ceramic capacitor to ensure the same minimum capacitance over the equivalent operating temperature range.

4.3 No Load Stability

The MIC94310 will remain stable and in regulation with no load. This is especially important in CMOS RAM keep-alive applications.

4.4 Enable/Shutdown

Forcing the enable (EN) pin low disables the MIC94310 and sends it into a "zero" off mode current state. In this state, current consumed by the MIC94310 goes nearly to zero. Forcing EN high enables the output voltage. The EN pin uses CMOS technology and cannot be left floating as it could cause an indeterminate state on the output.

4.5 Thermal Considerations

The MIC94310 is designed to provide 200 mA of continuous current in a very small package. Maximum ambient operating temperature can be calculated based on the output current and the voltage drop across the part. For example if the input voltage is 2.5V, the output voltage is 1.8V, and the output current equals 200 mA. The actual power dissipation of the Ripple Blocker can be determined using Equation 4-1:

EQUATION 4-1:

$$P_D = (V_{IN} - V_{OUT1})I_{OUT} + V_{IN}I_{GND}$$

Because this device is CMOS and the ground current is typically <170 μ A over the load range, the power dissipation contributed by the ground current is <1% and can be ignored for the calculation shown in Equation 4-2 and Equation 4-3.

EQUATION 4-2:

$$P_D = (2.5V - 1.8V) \times 200 \text{ mA}$$

EQUATION 4-3:

$$P_D = 0.14W$$

To determine the maximum ambient operating temperature of the package, use the junction-to-ambient thermal resistance of the device and the Equation 4-4:

EQUATION 4-4:

$$P_{D(MAX)} = \left(\frac{T_{J(MAX)} - T_A}{\theta_{JA}}\right)$$

 $T_{J(MAX)}$ = 125°C, the maximum junction temperature of the die, θ_{JA} thermal resistance = 173°C/W for the Thin DFN package.

Substituting P_D for $P_{D(MAX)}$ and solving for the ambient operating temperature will give the maximum operating conditions for the regulator circuit.

For proper operation, the maximum power dissipation must not be exceeded.

For example, when operating the MIC94310-GYMT at an input voltage of 2.5V and 200 mA load with a minimum footprint layout, the maximum ambient operating temperature (T_A) can be determined as follows:

EQUATION 4-5:

```
0.14W = (125^{\circ}C - T_A)/(173^{\circ}C/W)
```

EQUATION 4-6:

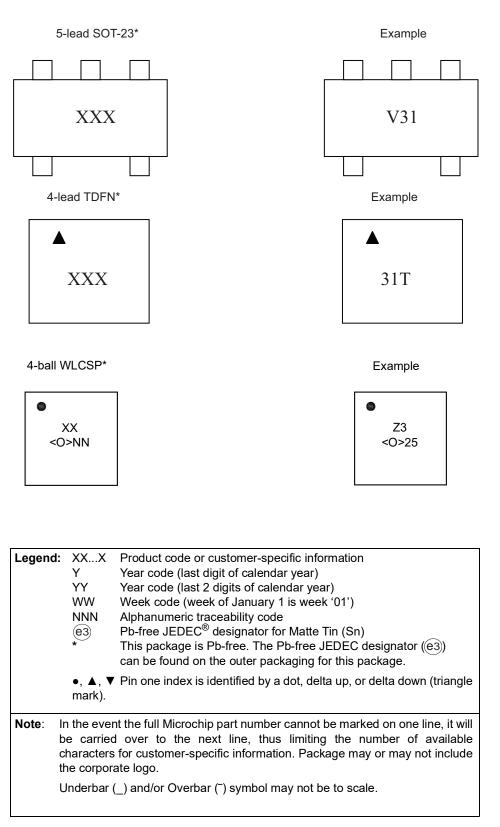
 $T_A = 101^{\circ}C$

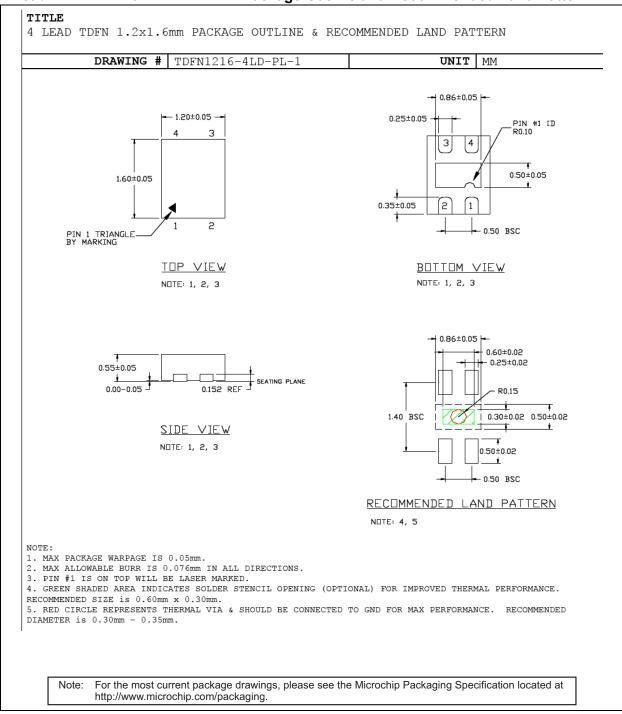
Therefore, the maximum ambient operating temperature allowed in a 1.2 mm \times 1.6 mm Thin DFN package is 101°C.

^{© 2018-2020} Microchip Technology Inc.

5.0 PACKAGING INFORMATION

5.1 Package Marking Information

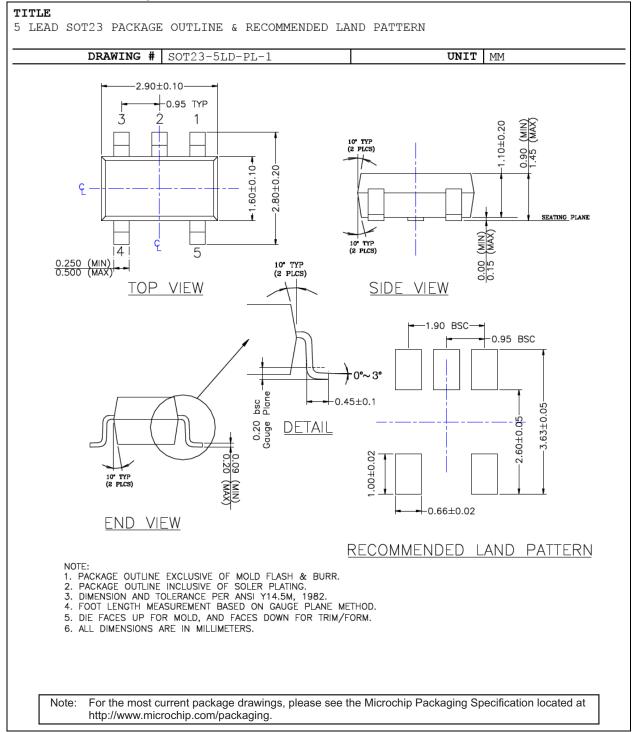


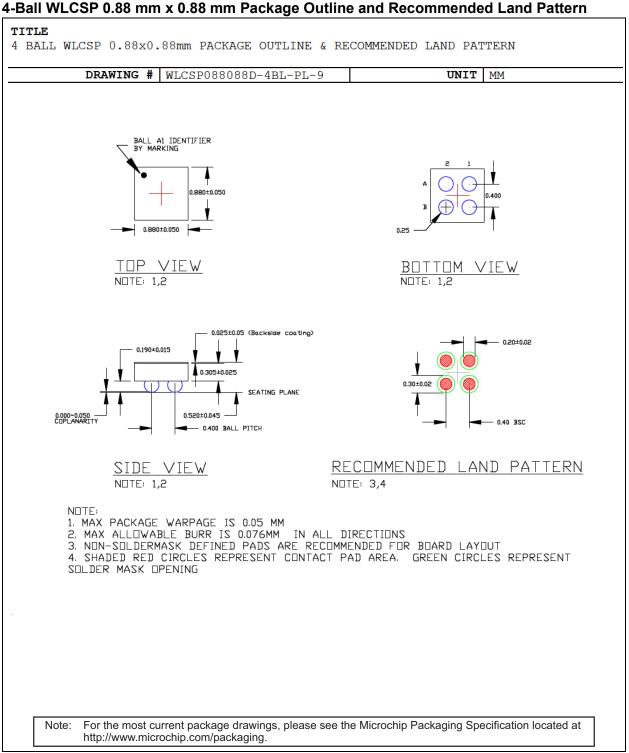


4-Lead 1.2 mm × 1.6 mm Thin DFN Package Outline and Recommended Land Pattern

© 2018-2020 Microchip Technology Inc.

5-Pin SOT-23 Package Outline and Recommended Land Pattern





^{© 2018-2020} Microchip Technology Inc.

NOTES:

APPENDIX A: REVISION HISTORY

Revision B (September 2020)

• Added 0.88 mm × 0.88 mm 4-Ball WLCSP package.

Revision A (October 2018)

- Converted Micrel document MIC94310 to Microchip data sheet template DS20006105A.
- Minor grammatical text changes throughout.

^{© 2018-2020} Microchip Technology Inc.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	- <u>X</u>	<u>×</u>	<u>XX</u>	- <u>XX</u>	EXC	amples:	
Device	T Output Voltage	t Temperature	Package	Media Type	a)	MIC94310-4YMT-T5:	200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, –40°C to +85°C Temperature Range, 5-Lead TDFN, 5,000/ Reel
Device:	MIC94310:	200 mA LDO with Ri	pple Blocker [™]	Technology	b)	MIC94310-4YMT-TR:	200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature
Output Voltage:	F = G = D = J =	1.2V 1.5V 1.8V 1.85V 2.5V 2.7V			c)	MIC94310-4YM5-T5:	Range, 5-Lead TDFN, 5,000/ Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature Range, 5-Lead SOT-235,000/
	N = P =	2.8V 2.85V 3.0V 3.3V			d)	MIC94310-4YM5-TR:	Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, –40°C to +85°C Temperature Range, 5-Lead
Temperature Range:	Y = E =	-40°C to +85°C -40°C to +125°C			e)	MIC94310-4YMT-T5:	SOT-23, 5,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature
Packages:	M5 =	4-Lead 1.2 mm × 1.6 r 5-Lead SOT-23 4-Ball 0.88 mm × 0.88			f)	MIC94310-4YMT-TR:	Range, 5-Lead TDFN, 5,000/ Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +88°C Temperature
Media Type:	TR = TR =	3,000/Reel (SOT-23) 5,000/Reel (TDFN) 3,000/Reel (WLCSP) 500/Reel			g)	MIC94310-4YM5-T5:	Range, 5-Lead TDFN, 5,000/ Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature Range, 5-Lead SOT-23 5,000/
					h)	MIC94310-4YM5-TR:	Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2V Output Voltage, -40°C to +85°C Temperature
					i)	MIC94310-4YCS-TR:	Range, 5-Lead SOT-23, 5,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 1.2 Output Voltage -40°C to +125°C
					j)	MIC94310-GYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 1.8 Output Voltage -40°C to +125°C
					k)	MIC94310-JYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 2.5 Output Voltage -40°C to +125°C
					I)	MIC94310-MYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 2.8 Output Voltage -40°C to +125°C
					m)	MIC94310-PYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 0.0 Output Voltage -40°C to +125°C
catalog pa identifier i is not prin	art number des s used for orde ted on the dev	only appears in the scription. This ering purposes and vice package. Check es Office for package			n)	MIC94310-SYCS-TR:	Extended Temperature Range, 4-Ball WLCSP 3,000/Reel 200 mA LDO with Ripple Blocker™ Technology, 3.3 Output Voltage -40°C to +125°C Extended Temperature Range,

NOTES:

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- · Microchip believes that its family of products is secure when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods being used in attempts to breach the code protection features of the Microchip devices. We believe that these methods require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Attempts to breach these code protection features, most likely, cannot be accomplished without violating Microchip's intellectual property rights.
- Microchip is willing to work with any customer who is concerned about the integrity of its code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not
 mean that we are guaranteeing the product is "unbreakable." Code protection is constantly evolving. We at Microchip are
 committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection
 feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or
 other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication is provided for the sole purpose of designing with and using Microchip products. Information regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WAR-RANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDI-RECT, SPECIAL, PUNITIVE, INCIDENTAL OR CONSEQUEN-TIAL LOSS, DAMAGE, COST OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AnyRate, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PackeTime, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TempTrackr, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

APT, ClockWorks, The Embedded Control Solutions Company, EtherSynch, FlashTec, Hyper Speed Control, HyperLight Load, IntelliMOS, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, Temux, TimeCesium, TimeHub, TimePictra, TimeProvider, Vite, WinPath, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, Anyln, AnyOut, BlueSky, BodyCom, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, INICnet, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet Iogo, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified Iogo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

 $\ensuremath{\textcircled{\sc 0}}$ 2018-2020, Microchip Technology Incorporated, All Rights Reserved.

ISBN: 978-1-5224-6705-2

© 2018-2020 Microchip Technology Inc.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110 Tel: 408-436-4270

Canada - Toronto Tel: 905-695-1980 Fax: 905-695-2078

DS20006105B-page 22

ASIA/PACIFIC

Australia - Sydney Tel: 61-2-9868-6733

China - Beijing Tel: 86-10-8569-7000 China - Chengdu

Tel: 86-28-8665-5511 China - Chongqing Tel: 86-23-8980-9588

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

China - Hangzhou Tel: 86-571-8792-8115

China - Hong Kong SAR Tel: 852-2943-5100

China - Nanjing Tel: 86-25-8473-2460

China - Qingdao Tel: 86-532-8502-7355

China - Shanghai Tel: 86-21-3326-8000

China - Shenyang Tel: 86-24-2334-2829

China - Shenzhen Tel: 86-755-8864-2200

China - Suzhou Tel: 86-186-6233-1526

China - Wuhan Tel: 86-27-5980-5300

China - Xian Tel: 86-29-8833-7252

China - Xiamen Tel: 86-592-2388138 China - Zhuhai

Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444

Tel: 91-11-4160-8631 India - Pune

Tel: 91-20-4121-0141 Japan - Osaka

Tel: 81-6-6152-7160 Japan - Tokyo

Tel: 81-3-6880- 3770 Korea - Daegu

Tel: 82-53-744-4301 Korea - Seoul

Tel: 82-2-554-7200

Malaysia - Kuala Lumpur Tel: 60-3-7651-7906

Malaysia - Penang Tel: 60-4-227-8870

Philippines - Manila Tel: 63-2-634-9065

Singapore Tel: 65-6334-8870

Taiwan - Hsin Chu Tel: 886-3-577-8366

Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600

Thailand - Bangkok Tel: 66-2-694-1351

Vietnam - Ho Chi Minh Tel: 84-28-5448-2100

Tel: 31-416-690399 Fax: 31-416-690340

Italy - Padova

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Tel: 45-4485-5910

Fax: 45-4485-2829

Tel: 358-9-4520-820

Tel: 33-1-69-53-63-20

Fax: 33-1-69-30-90-79

Germany - Garching

Tel: 49-2129-3766400

Germany - Heilbronn

Germany - Karlsruhe

Tel: 49-7131-72400

Tel: 49-721-625370

Germany - Munich

Tel: 49-89-627-144-0

Fax: 49-89-627-144-44

Germany - Rosenheim

Tel: 49-8031-354-560

Israel - Ra'anana

Italy - Milan

Tel: 972-9-744-7705

Tel: 39-0331-742611

Fax: 39-0331-466781

Tel: 39-049-7625286

Netherlands - Drunen

Tel: 49-8931-9700

Germany - Haan

Finland - Espoo

France - Paris

Fax: 43-7242-2244-393

Denmark - Copenhagen

Norway - Trondheim Tel: 47-7288-4388

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

Tel: 91-80-3090-44 India - New Delhi